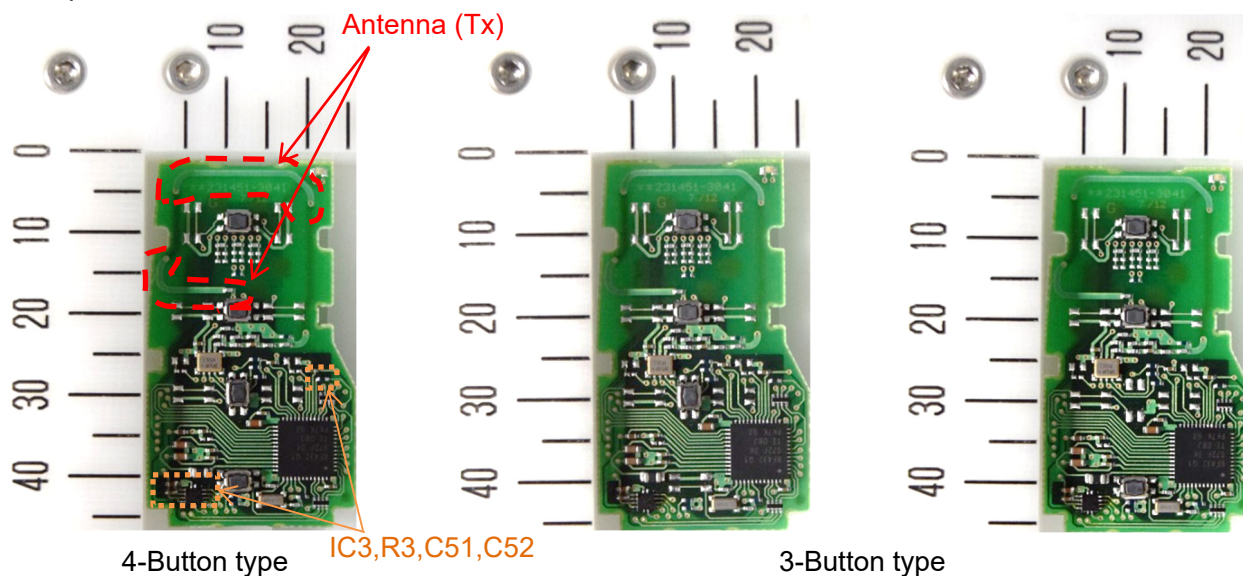


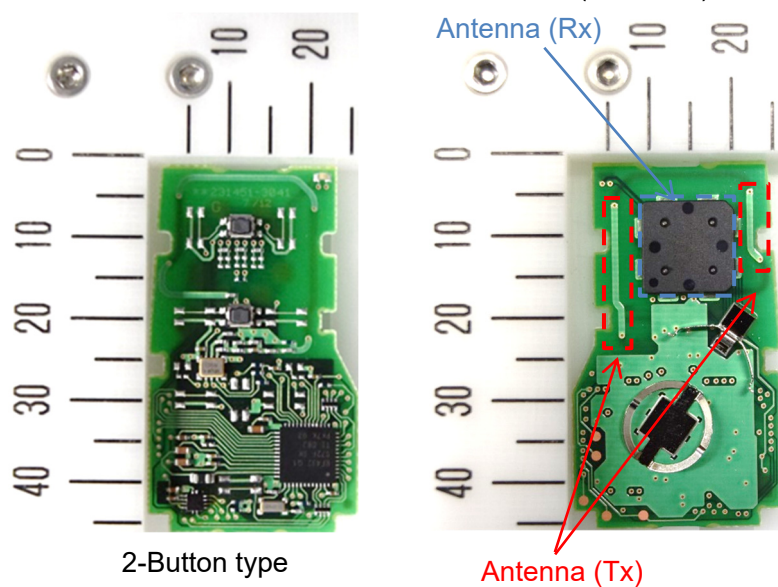
**DENSO CORPORATION**  
**Electronic Key**  
**FCC ID: HYQ14FGZ**  
**IC Number: 1551A-14FGZ**

Internal Photos (Type A: IC3, R3, C51 and C52 are mounted.)

Component side

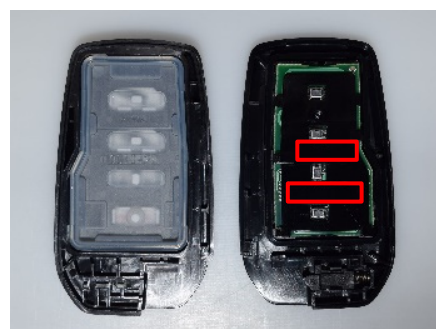


Solder side (Common)

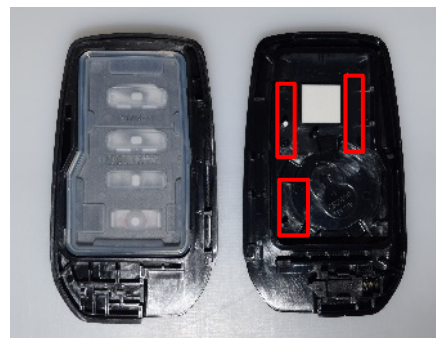


Marking location

< Inside the outer case >



< On the module cover >



Note:

The difference in the number and / or location of switches has no influence on RF performance.

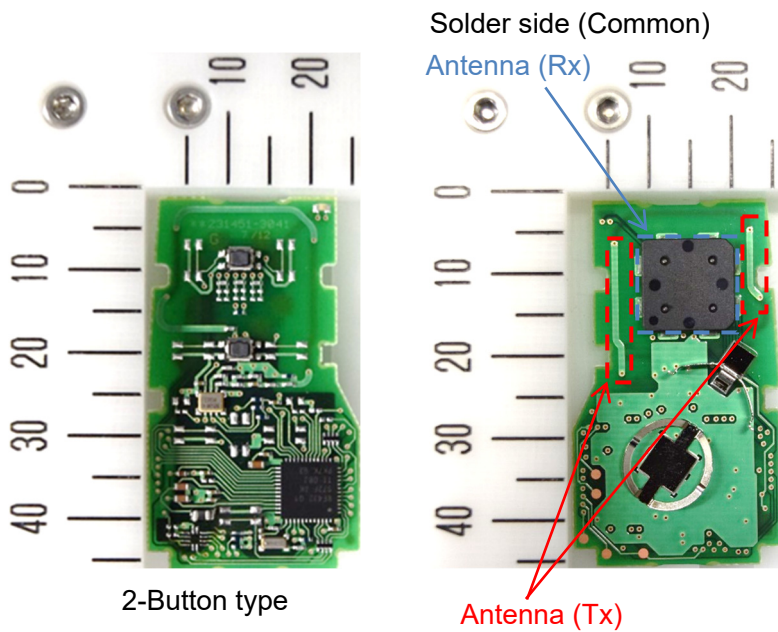
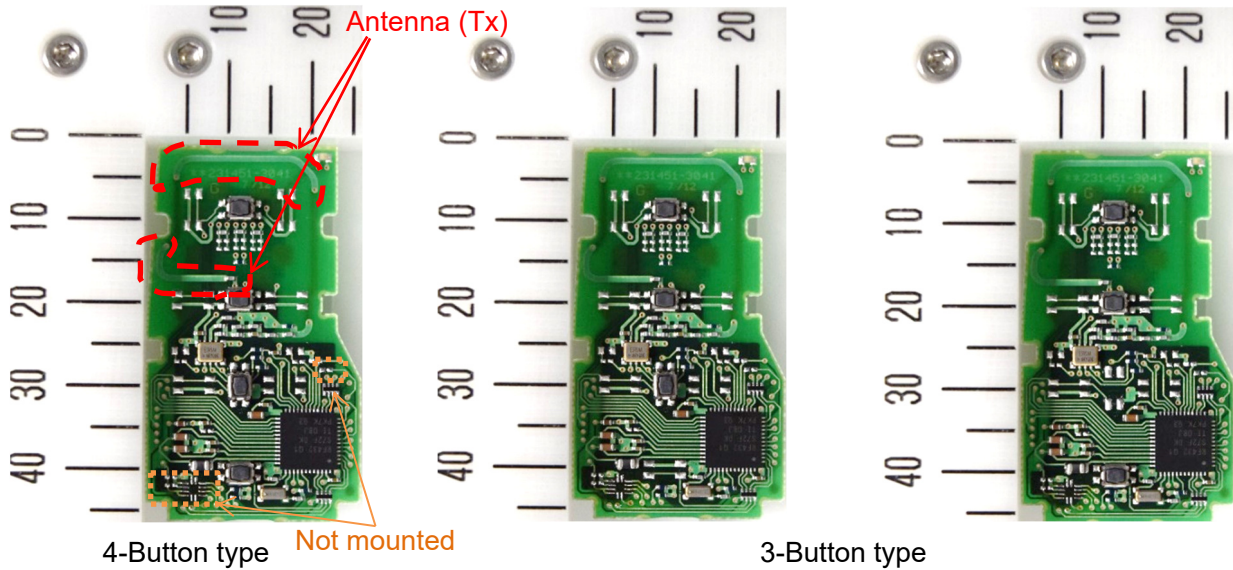
Type A and Type B are equivalent in terms of RF performance.

Marking location is inside the outer case or on the module cover.

**DENSO CORPORATION**  
**Electronic Key**  
**FCC ID: HYQ14FGZ**  
**IC Number: 1551A-14FGZ**

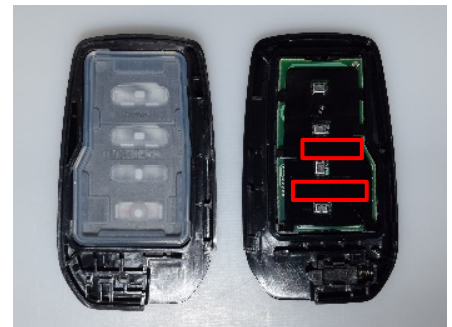
Internal Photos (Type B: IC3, R3, C51 and C52 are not mounted.)

Component side

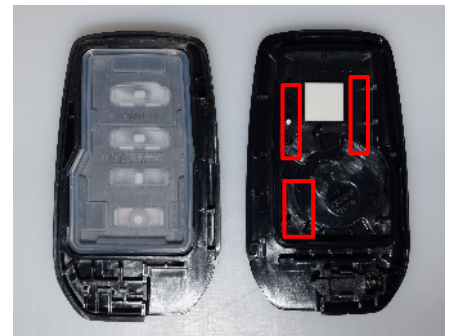


Marking location

< Inside the outer case >



< On the module cover >



Note:

The difference in the number and / or location of switches has no influence on RF performance.

Type A and Type B are equivalent in terms of RF performance.

Marking location is inside the outer case or on the module cover.